1-2199298-2 <

DIPLOMATE TE Internal #: 1-2199298-2 DIP Sockets, Stamped & Formed, 8 Position, Low Profile, Through Hole, Tin, -40 – 105 °C [-40 – 221 °F]

View on TE.com >



Connectors > Socket Connectors > IC Sockets > DIP Sockets > DIP Socket: Low Profile, Stamped & Formed, Open, Tin



Contact Fabrication: Stamped & Formed

Number of Positions: 8

Connector Profile: Low

Row-to-Row Spacing: 7.62 mm [.3 in]

Leg Style: Through Hole

All DIP Socket: Low Profile, Stamped & Formed, Open, Tin (6)

Features

Product Type Features

Connector & Contact Terminates To

Lea Style

Printed Circuit Board

Through Hole

Configuration Features

Number of Rows	2
PCB Mount Orientation	Vertical
Number of Positions	8
Electrical Characteristics	
Insulation Resistance	1000 MΩ
Contact Resistance	20 mΩ
Body Features	
Sleeve Material	Brass/Copper
Sleeve Plating Material	Tin/Lead
Frame Style	Ladder
Connector Profile	Low
Contact Features	
Mating Contact Type	Dual Leaf

DIP Sockets, Stamped & Formed, 8 Position, Low Profile, Through Hole, Tin, -40 – 105 °C [-40 – 221 °F]



IC Socket Type	DIP
Contact Type	Pin
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Fabrication	Stamped & Formed
Contact Mating Area Plating Material	Tin
	60 µin
Contact Current Rating (Max)	1 A
Termination Features	
	3 in
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Alignment	With
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	PBT GF30
Housing Color	Black
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Profile Height from PCB	5.1 mm[.2 in]
Product Length	10.16 mm[.4 in]
Row-to-Row Spacing	7.62 mm[.3 in]
Usage Conditions	
Operating Temperature Range	-40 – 105 °C[-40 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Tubes per Box	2
Packaging Quantity	60

DIP Sockets, Stamped & Formed, 8 Position, Low Profile, Through Hole, Tin, -40 – 105 °C [-40 – 221 °F]



Packaging Method	Box & Tube
Other	
Quantity per Tube	6000
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Canability	Wave solder capable to 240°C

Solder Process Capability

Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge

based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



DIP Sockets, Stamped & Formed, 8 Position, Low Profile, Through Hole, Tin, -40 – 105 °C [-40 – 221 °F]





TE Part # 5787617-8 RECP ASSY, R/A, STACKED, THRU-HOLE, USB,



TE Part # 5787745-2 USB A R/A STAK ASSY THRU HOLE



TE Part # 5787745-4 USB A R/A STAK ASSY THRU HOLE



TE Part # 5787617-1 RECP ASSY, R/A, STACKED, THRU-HOLE, USB,



TE Part # 5787617-2 RECP ASSY, R/A, STACKED, THRU-HOLE, USB,



TE Part # 292323-6 REC ASSY RIGHT ANGLE STACKED THRUHOLE US



TE Part # 5787617-5 RECP ASSY, R/A, STACKED, THRU-HOLE, USB,



TE Part # 5787617-6 RECP ASSY, R/A, STACKED, THRU-HOLE, USB,



TE Part # 5787745-3 USB A R/A STAK ASSY THRU HOLE



TE Part # 292323-1 REC ASSY RIGHT ANGLE STACKED THRUHOLE US



TE Part # 292323-5 RECEPTACLE ASSY RIGHT ANGLE STACKED THRU

Customers Also Bought



DIP Sockets, Stamped & Formed, 8 Position, Low Profile, Through Hole, Tin, -40 – 105 °C [-40 – 221 °F]





Documents

Product Drawings 8P,DIP SKT,300 CL,LDR,PB FREE

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-2199298-2_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-2199298-2_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-2199298-2_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages DIP Sockets Quick Reference Guide (EN)

English